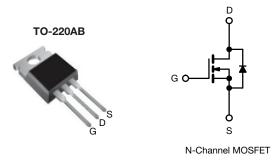
**Vishay Siliconix** 



# **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	550			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.243		
Q <sub>g</sub> max. (nC)	66			
Q <sub>gs</sub> (nC)	8			
Q <sub>gd</sub> (nC)	14			
Configuration	Single			

## **FEATURES**

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Computing
  - PC silver box / ATX power supplies
- Lighting
  - Two stage LED lighting
- Consumer electronics
- · Applications using hard switched topologies
  - Power factor correction (PFC)
  - Two switch forward converter
  - Flyback converter
- Switch mode power supplies (SMPS)

# ORDERING INFORMATION Package TO-220AB SiHD15N50E RE3.8

Fackage	TU-22UAD		
Lead (Pb)-free and halogen-free	SiHP15N50E-BE3 <sup>a</sup>		
Lead (PD)-free and halogen-free	SiHP15N50E-GE3		

#### Note

a. "-BE3" denotes alternate manufacturing location

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V <sub>DS</sub>	500	V		
Gate-Source Voltage			V <sub>GS</sub>	± 30	v		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V =======V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub>	14.5			
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		9.2	A		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	28			
Linear Derating Factor				1.25	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	136	mJ		
Maximum Power Dissipation			PD	156	W		
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-Source Voltage Slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		d\//dt	70	V/ns		
Reverse Diode dV/dt <sup>d</sup>			dV/dt	27	v/ns		
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s			300	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 3.1 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, dl/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$ 

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.8	0/10	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	500	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, $I_D = 1 \text{ mA}$		0.62	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	4.0	V
Onto any laskana	I <sub>GSS</sub>	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-source leakage		Ň	/ <sub>GS</sub> = ± 30 V	-	-	± 1	μA
Zara acto voltogo duoin ovument	1	V <sub>DS</sub> =	500 V, V <sub>GS</sub> = 0 V	-	-	10	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 V	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	25	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 7.5 A	-	0.243	0.280	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 7.5 A		-	3.9	-	S
Dynamic		-		•	•	•	
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1162	-	pF
Output capacitance	C <sub>oss</sub>			-	51	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	7	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0$ V to 400 V, $V_{GS} = 0$ V		-	55	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	164	-	
Total gate charge	Qg			-	33	66	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$V_{GS} = 10 \text{ V}$ $I_D = 7.5 \text{ A}, V_{DS} = 400 \text{ V}$		8	-	nC
Gate-drain charge	Q <sub>gd</sub>				14	-	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 12 A,		-	15	30	- ns
Rise time	t <sub>r</sub>			-	24	48	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		34	68	
Fall time	t <sub>f</sub>	1		-	18	36	
Gate input resistance	Rg	f = 1 MHz, open drain		-	0.85	-	Ω
Drain-Source Body Diode Characteristic	s			•	•	•	
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14.5	
Pulsed diode forward current	I <sub>SM</sub>			-	-	28	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 7.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 7.5 \text{ A},$ dl/dt = 100 A/ $\mu$ s <sup>, V</sup> <sub>R</sub> = 25 V		-	265	-	ns
Reverse recovery charge	Q <sub>rr</sub>			-	3.2	-	μC
Reverse recovery current	I <sub>RRM</sub>			-	23	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

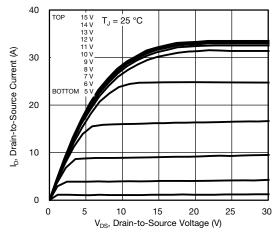


Fig. 1 - Typical Output Characteristics

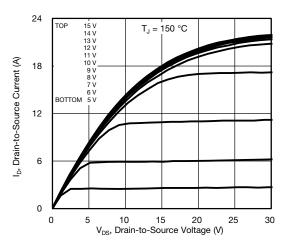


Fig. 2 - Typical Output Characteristics

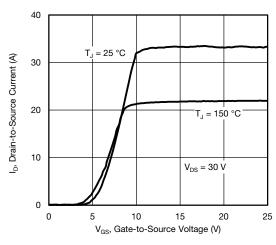


Fig. 3 - Typical Transfer Characteristics

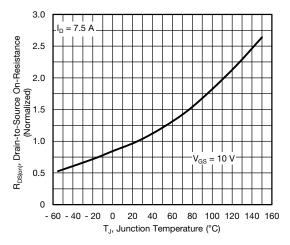


Fig. 4 - Normalized On-Resistance vs. Temperature

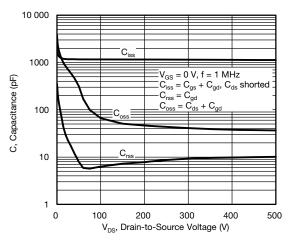


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

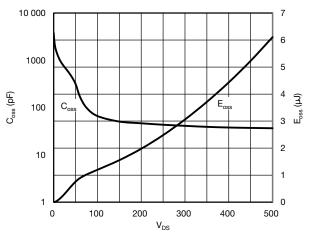


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 

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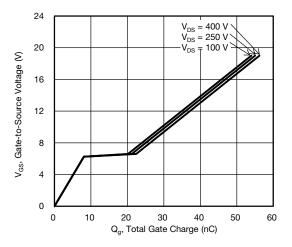


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

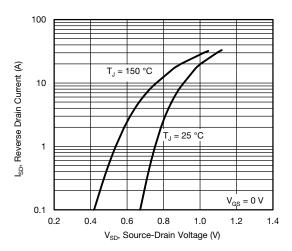
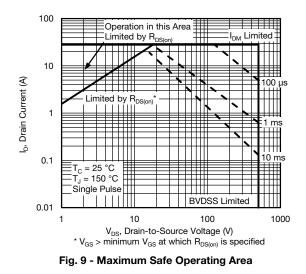


Fig. 8 - Typical Source-Drain Diode Forward Voltage



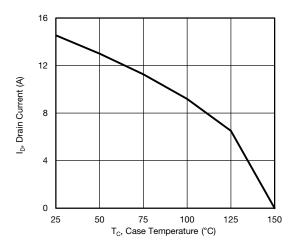


Fig. 10 - Maximum Drain Current vs. Case Temperature

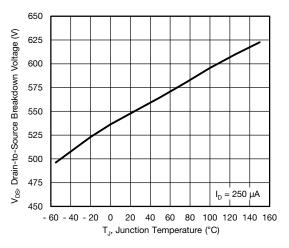
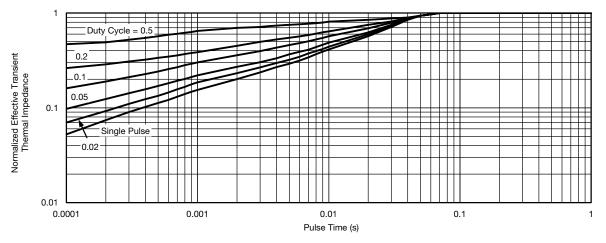


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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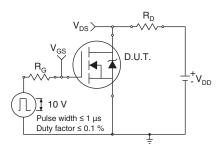


Fig. 13 - Switching Time Test Circuit

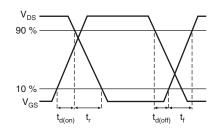


Fig. 14 - Switching Time Waveforms

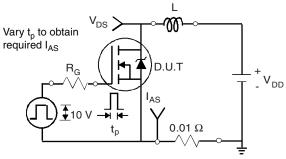


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

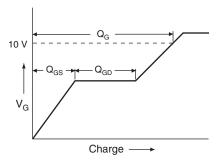


Fig. 17 - Basic Gate Charge Waveform

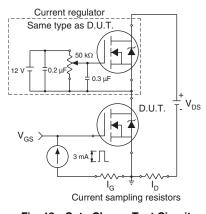


Fig. 18 - Gate Charge Test Circuit

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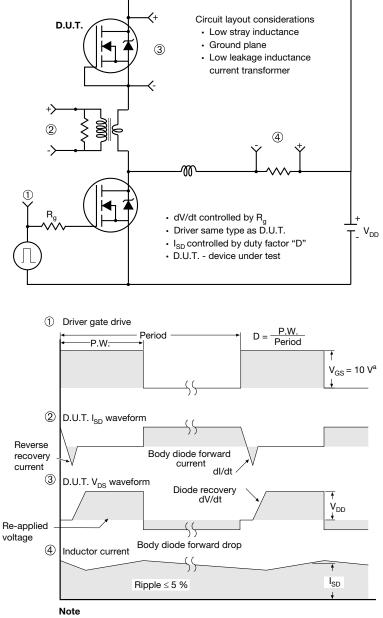
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

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